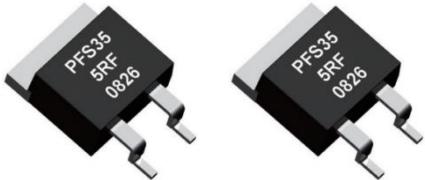


# TFS35 Series

## TO220 High Power Thick Film SMD Resistors



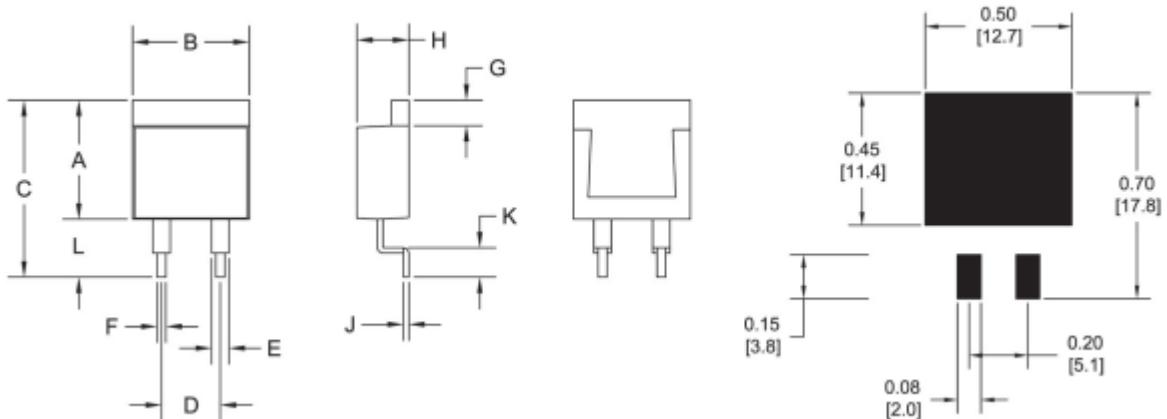
- D2PAK Housing
- Resistances From 0.01Ohm to 500kOhms
- 35 Watts At 25°C Case Temperature On Heat Sink
- Resistance Tolerances to ±1%
- TCR to ±50ppm/°C
- Load Stability to 1%
- Low Ohm Values For Current Sense Applications
- Exceptional Pulse Performance
- Solder Reflow Secure At 250°C / 30s
- Electrically Isolated From Back Plate
- Low Inductance - 0.1µH Maximum
- RoHS Compliant
- Flammability UL94V-0

### ■ SPECIFICATIONS

Type	TFS35				
Terminals	2				
Terminal Finish	Tin Plated Copper				
Power Rating (with heat sink)	35 W (2W on Simple solder Pad)				
Thermal Resistance Rthj-c	3.4°C/W				
Resistance Range	0.01 to 0.099Ohms	0.1 to 9.90Ohms	10 to 100KOhms		
Tolerances (others upon request)	5%	1% / 5%	1%		
Temperature Coefficient	±250 ppm/°C	±100 ppm/°C	±50 ppm/°C		
Operating Temperature	-55°C to 175°C				
Max Operating Voltage	500VDC				
Inductance	0.1uH				
Voltage Proof	2.0kVDC				
Insulation Resistance	Over 4,000 Mega ohm				
Dielectric strength	2,000VDC				
Load Life	±1%	90 min ON, 30 min OFF, 1000hrs @ 25°C			
Humidity	±1%	90-95% RH, 0.1W, 1000 hrs @ 40°C			
Temperature Cycle	±0.25%	-55°C for 30 min, +155°C for 30 min, 5cycles			
Solder Heat	±0.1%	350°C ±5°C for 3 seconds			
Vibration	±0.25%	5G 10~2Khz 20min / 12cycles			
Flammability	UL94V-0				
Reflow soldering	250°C / 30s / 3cycles (sufficient cooling between each cycles)				
Moisture Sensitivity Level	MSL-1				
Mass	1.5g				

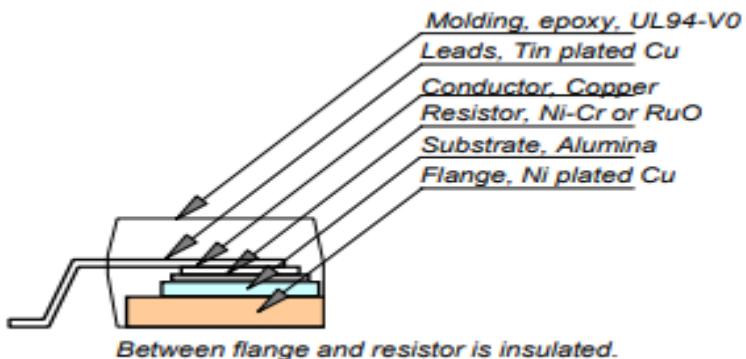
## DIMENSIONS

Back plate is isolated from both pins.



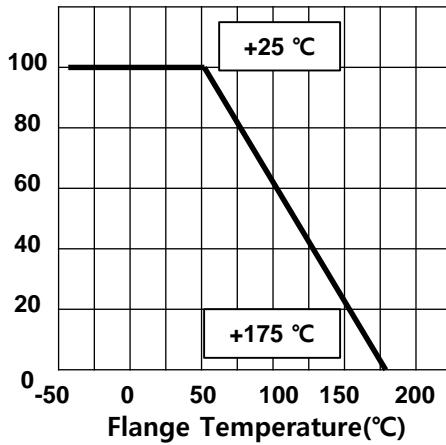
Dimension	mm	Tol (±mm)	inches	Tol (±inches)
A	10.3	0.2	0.405	0.008
B	10.1	0.2	0.400	0.008
C	15.3	1.2	0.602	0.047
D	5.08	0.1	0.200	0.004
E	1.5	0.05	0.060	0.002
F	0.75	0.05	0.030	0.002
G	2.2	0.2	0.087	0.008
H	4.5	0.2	0.177	0.008
J	0.5	0.05	0.020	0.002
K	2.5	0.5	0.10	0.02
L	5.0	1.0	0.20	0.04

## Structure and Materials



## □ DERATING CURVES

### % Power



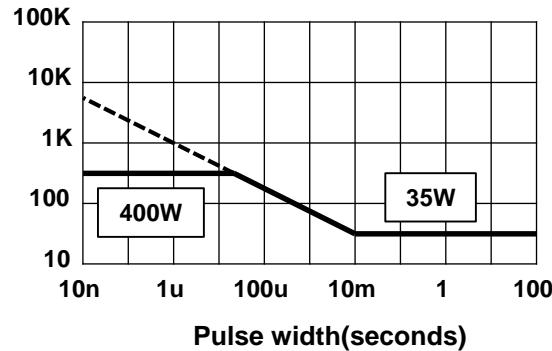
### Power Rating Notes-

The TFS35 Series Resistors must be attached to a suitable heatsink.  
The maximum internal resistor temperature is 175°C  
To specify an appropriate heatsink use the following formula

$$R_{\text{eff}} = \frac{T_{\text{MAX}} - (P * R_{\text{eff}}) - T_{\text{A}}}{P}$$

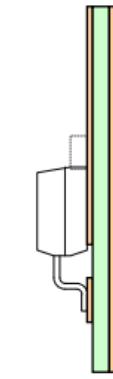
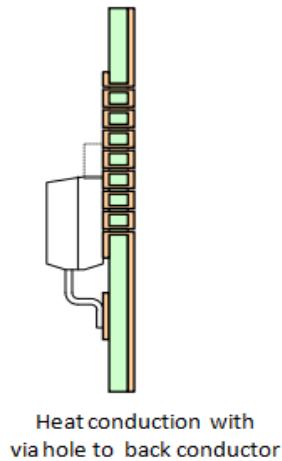
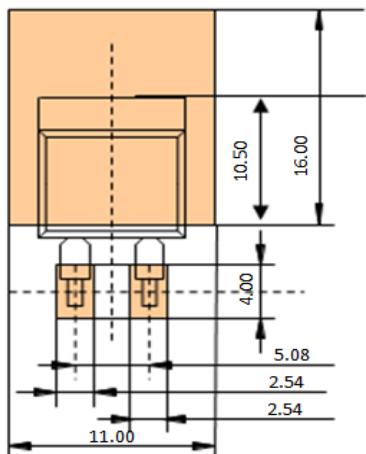
Where:  
 $R_{\text{H}}$  = Thermal Resistance of Heatsink (K/W)  
 $R_{\text{R}}$  = Thermal Resistance of Resistor (K/W)  
 $T_{\text{MAX}}$  = Maximum Temperature of Resistor  
 $T_{\text{A}}$  = Ambient Temperature of Heatsink (°C)  
 $P$  = Power Through Resistor (W)

### Pulse Peak Power(W)

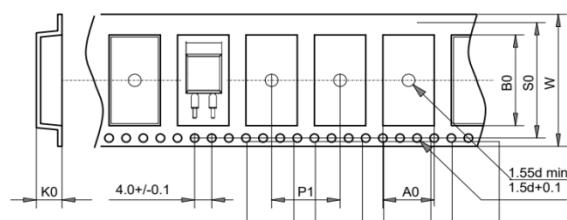


Tentative continuous-pulse allowance at duty 0.01. Load life test will be necessary in actual equipment, because curve may be changed by resistance, repetition, duty and operating temperature

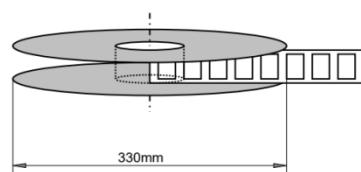
### Applications .TFS35



### Tape Reel ,TPFS35 (500pcs/reel)

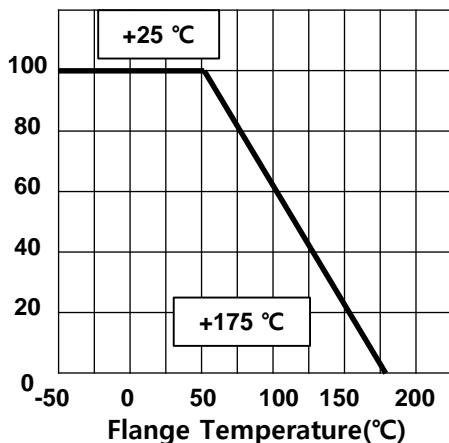


A0	12+/-0.3
B0	16+/-0.3
K0	6.1+/-0.3
P1	16+/-0.3
S0	20+/-0.3
W	24+/-0.3



## □ DERATING CURVES

### % Power



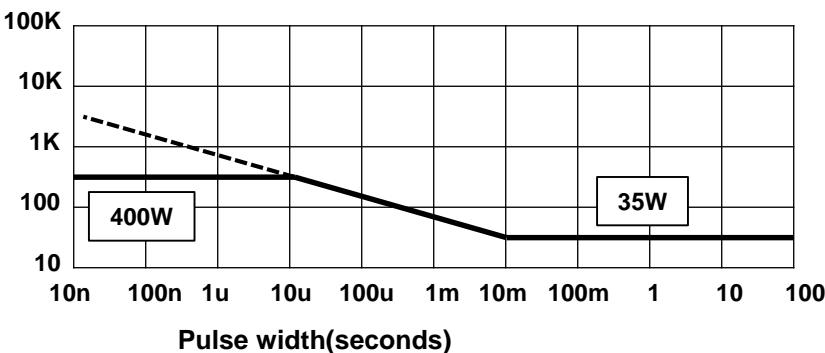
#### Power Rating Notes-

The TFS35 Series Resistors must be attached to a suitable heatsink.  
The maximum internal resistor temperature is 175°C  
To specify an appropriate heatsink use the following formula

$$R_{\text{eff}} = \frac{T_{\text{MAX}} - (P * R_{\theta R}) - T_A}{P}$$

Where:   
 $R_{\text{IH}}$  = Thermal Resistance of Heatsink ( K/W )  
 $R_{\theta R}$  = Thermal Resistance of Resistor ( K/W )  
 $T_{\text{MAX}}$  = Maximum Temperature of Resistor  
 $T_A$  = Ambient Temperature of Heatsink ( °C )  
 $P$  = Power Through Resistor ( W )

### Pulse Peak Power(W)



Tentative continuous-pulse allowance at duty 0.01. Load life test will be necessary in actual equipment, because curve may be changed by resistance, repetition, duty and operating temperature

## □ HOW TO ORDER

TFS35	10KΩ	±1%	NOTE
TYPE	RESISTANCE	TOLERANCE ±1% ±5%	TAPE 500Pcs Packaging